LNJ808R83RA

Hight Bright Surface Mounting Chip LED

SS Type

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol Rating		Unit	
Power dissipation	P_{D}	55	mW	
Forward current	I_{F}	mA		
Pulse forward current *	I_{FP}	100	mA	
Reverse voltage	V _R	4	V	
Operating ambient temperature	T _{opr}	-25 to +85	°C	
Storage temperature	T _{stg}	-40 to +100	°C	

■ Lighting Color

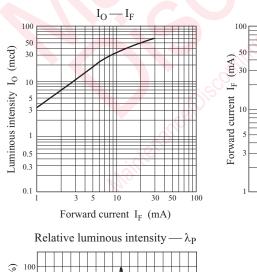
Orange

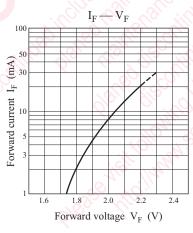
Note) *: The condition of I_{FP} is duty 10%, Pulse width 1 msec.

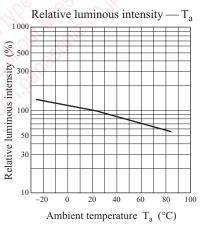
■ Electro-Optical Characteristics $T_a = 25$ °C±3°C

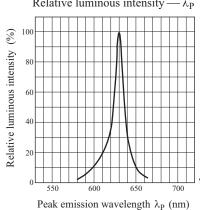
Parameter	Symbol		Conditions	Min	Тур	Max	Unit
Luminous intensity *	I_{O}	$I_F = 10 \text{ mA}$	\$ \qua	17	32		mcd
Reverse current	I_R	$V_R = 4 V$	illo)			10	μΑ
Forward voltage	V _F	$I_F = 10 \text{ mA}$	301(07		2.03	2.50	V
Peak emission wavelength	$\lambda_{ m P}$	$I_F = 10 \text{ mA}$	104111	_	630		nm
Spectral half band width	Δλ	$I_F = 10 \text{ mA}$	10) Sell 1108 1109	8	15	//	nm

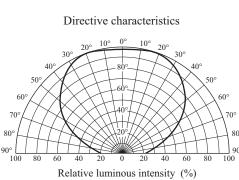
Note) *: Measurement tolerance: ±20%

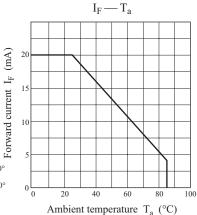








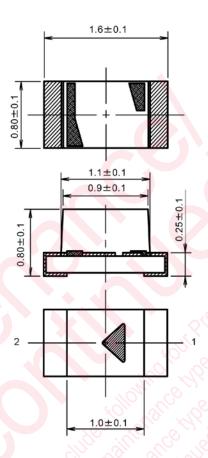




LNJ808R83RA Panasonic

■ Package (Unit: mm)

KLTFTN2K0800



- Pin name
 - 1: Anode
 - 2: Cathode

2 SHD00662BEK

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